



07-23-01

PATENT APPLICATION
Attorney's Do. No. 9903-19

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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DATE OF DEPOSIT: JULY 19, 2001

I HEREBY CERTIFY THAT THIS PAPER AND ENCLOSURES AND/OR FEE ARE BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE" SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED ABOVE AND IS ADDRESSED TO: BOX PATENT APPLICATION, ASSISTANT COMMISSIONER FOR, PATENTS, WASHINGTON D.C. 20231.

EHREN RHEA
(SENDER'S PRINTED NAME)

(SIGNATURE)

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor: Young-Doo JUNG and Kwon-Young ROH:
For: LEAD FRAME HAVING A SIDE RING PAD AND
SEMICONDUCTOR CHIP PACKAGE INCLUDING THE SAME

Applicant requests FIG. 1 to be published with the application.

Enclosures:

- Specification (pages 1-5); claims (pages 6-8); abstract (page 9)
 THREE sheet(s) of FORMAL drawings
 Declaration or Combined Declaration and Power of Attorney
 Newly executed (original or copy)
 Assignment with cover sheet
Assignee Name and Address: Samsung Electronics Co., Ltd.
Suwon-City Kyungki-do, Korea
 Certified copy of priority document
 Return Postcard

<u>CLAIMS AS FILED</u>				
For	Number Filed	Number Extra	Rate	Basic Fee \$710
Total Claims	15-20	0	x \$ 18 =	0
Independent Claims	5-3	2	x \$ 80 =	160
TOTAL FILING FEE				\$870

- A check in the amount of \$870.00 to cover filing fee and a check for \$40.00 assignment recordal fee (\$40) is enclosed.
- Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A duplicate copy of this sheet is enclosed.

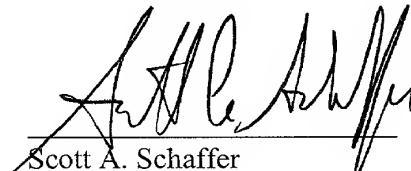


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PATENT TRADEMARK OFFICE

Respectfully submitted,

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